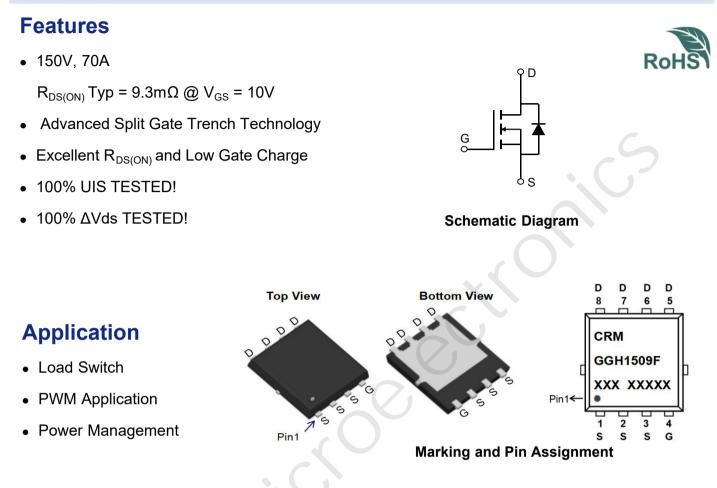


CRMGGH1509F

N-Channel 150V, 9.3mΩ Typ. Power MOSFET

Description



Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGH1509F	CRMGGH1509F	PDFN5x6-8L	TAPING	13"	5000	60000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		150	V
V _{GS}	Gate-to-Source Voltage		±20	V
Ι _D	Continuous Drain Current	$T_c = 25^{\circ}C$	70	А
		T _C = 100°C	42	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		280	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		264	mJ
PD	Power Dissipation	$T_c = 25^{\circ}C$	104	W
$R_{ ext{ hetaJC}}$	Thermal Resistance, Junction to Case		1.2	°C/W
Τ _J , T _{stg}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Char	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	150	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 150V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Char	acteristics				6	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2.4	3	3.6	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 30A	-	9.3	12	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	2274	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 75V, f = 1MHz	-	307	-	pF
C _{rss}	Reverse Transfer Capacitance		Χ-	12	-	pF
Qg	Total Gate Charge	(25	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 75V$, $I_{D} = 20A$	<u> </u>	10	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 75 v$, $I_{\rm D} = 20 A$	-	4	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	12	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 75V	-	9	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 10 Ω	-	16	-	ns
t _f	Turn-Off Fall Time		-	8	-	ns
Drain-So	ource Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	70	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	280	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	73	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 1A, di/dt = 100A/us		165	_	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J=25°C, V_{DD}=75V, V_G=10V, R_G=250hm, L=0.5mH, I_{AS}=32.5A

3. Pulse Test: Pulse Width \leqslant 300µs, Duty Cycle \leqslant 0.5%.



CRMGGH1509F

N-Channel 150V, 9.3mΩ Typ. Power MOSFET

Test Circuit

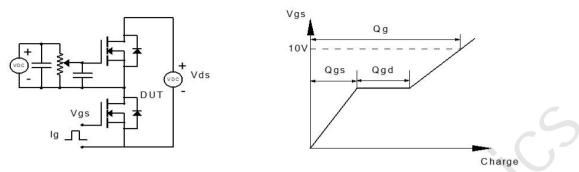


Figure 1: Gate Charge Test Circuit & Waveform

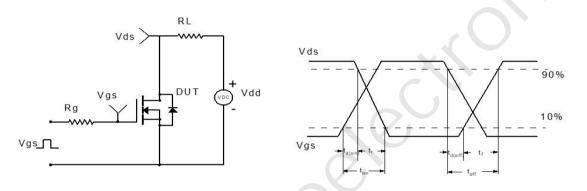
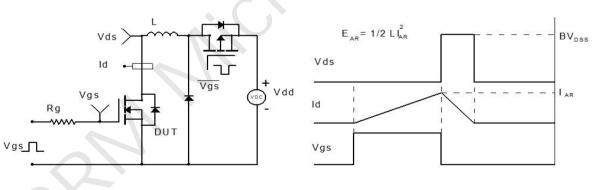


Figure 2: Resistive Switching Test Circuit & Waveform





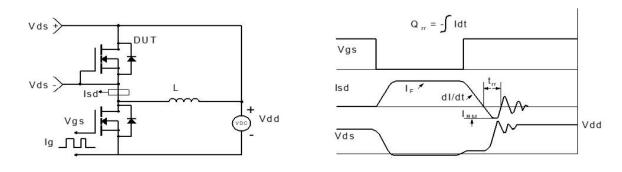
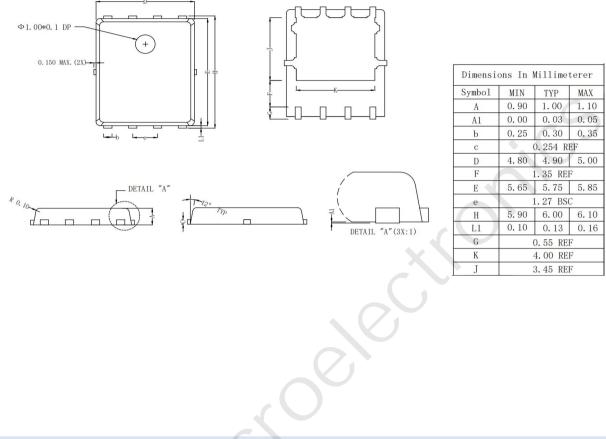


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(PDFN5x6-8L)



Important Notice

The information presented in datasheets is for reference only. CRM reserves the right to make changes at any time to any products or information herein, without notice. Customers are responsible for the design and applications, including compliance with all laws, regulations and safety requirements or standards.

"Typical" parameters which provided in datasheets can vary in different applications and actual performance may vary over time. Customers are responsible for doing all necessary testing to minimize the risks associated with their applications and products.

is a registered trademark of Wuxi CRM Microelectronics Co. , Ltd. Copyright ©2023 CRM Microelectronics Co. , Ltd. All rights reserved.

Contact information

For more information, please visit: http://www.crm-semi.tech For sales information, please send an email to: sales@crm-semi.com